

## 74ABT273 Octal D-Type Flip-Flop

### General Description

The ABT273 has eight edge-triggered D-type flip-flops with individual D inputs and Q outputs. The common buffered Clock (CP) and Master Reset ( $\overline{MR}$ ) inputs load and reset (clear) all flip-flops simultaneously.

The register is fully edge-triggered. The state of each D input, one setup time before the LOW-to-HIGH clock transition, is transferred to the corresponding flip-flop's Q output.

All outputs will be forced LOW independently of Clock or Data inputs by a LOW voltage level on the  $\overline{MR}$  input. The device is useful for applications where the true output only is required and the Clock and Master Reset are common to all storage elements.

### Features

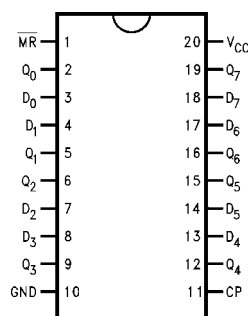
- Eight edge-triggered D-type flip-flops
- Buffered common clock
- Buffered, asynchronous Master Reset
- See ABT377 for clock enable version
- See ABT373 for transparent latch version
- See ABT374 for 3-STATE version
- Output sink capability of 64 mA, source capability of 32 mA
- Guaranteed latchup protection
- High impedance glitch free bus loading during entire power up and power down cycle
- Non-destructive hot insertion capability
- Disable time less than enable time to avoid bus contention

### Ordering Code:

| Order Number | Package Number | Package Description                                                             |
|--------------|----------------|---------------------------------------------------------------------------------|
| 74ABT273CSC  | M20B           | 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide Body |
| 74ABT273CSJ  | M20D           | 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide                   |
| 74ABT273CMSA | MSA20          | 20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide           |
| 74ABT273CMTC | MTC20          | 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide     |

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

### Connection Diagram



### Pin Descriptions

| Pin Names                      | Description                            |
|--------------------------------|----------------------------------------|
| D <sub>0</sub> –D <sub>7</sub> | Data Inputs                            |
| $\overline{MR}$                | Master Reset (Active LOW)              |
| CP                             | Clock Pulse Input (Active Rising Edge) |
| Q <sub>0</sub> –Q <sub>7</sub> | Data Outputs                           |

## Truth Table

| Operating Mode | Inputs                 |            |              | Output       |
|----------------|------------------------|------------|--------------|--------------|
|                | $\overline{\text{MR}}$ | CP         | $\text{D}_n$ | $\text{Q}_n$ |
| Reset (Clear)  | L                      | X          | X            | L            |
| Load "1"       | H                      | $\nearrow$ | h            | H            |
| Load "0"       | H                      | $\nearrow$ | l            | L            |

H = HIGH Voltage Level steady state

h = HIGH Voltage Level one setup time prior to the LOW-to-HIGH clock transition

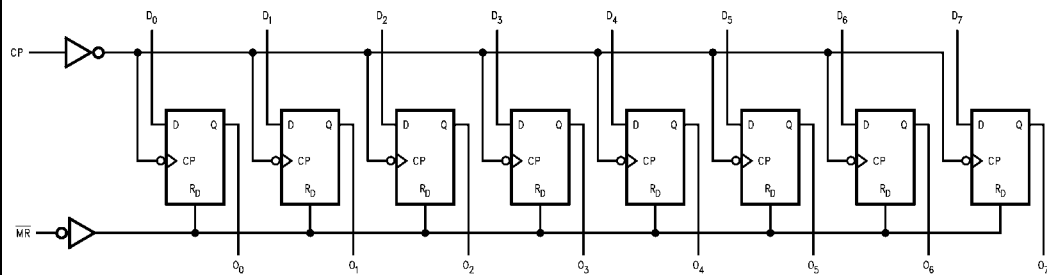
L = LOW Voltage Level steady state

l = LOW Voltage Level one setup time prior to the LOW-to-HIGH clock transition

X = Immaterial

$\nearrow$  = LOW-to-HIGH clock transition

## Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

**Absolute Maximum Ratings**(Note 1)

|                                                                        |                                      |
|------------------------------------------------------------------------|--------------------------------------|
| Storage Temperature                                                    | –65°C to +150°C                      |
| Ambient Temperature under Bias                                         | –55°C to +125°C                      |
| Junction Temperature under Bias                                        | –55°C to +150°C                      |
| V <sub>CC</sub> Pin Potential to Ground Pin                            | –0.5V to +7.0V                       |
| Input Voltage (Note 2)                                                 | –0.5V to +7.0V                       |
| Input Current (Note 2)                                                 | –30 mA to +5.0 mA                    |
| Voltage Applied to Any Output<br>in the Disabled or<br>Power-Off State | –0.5V to +4.75V                      |
| in the HIGH State                                                      | –0.5V to V <sub>CC</sub>             |
| Current Applied to Output<br>in LOW State (Max)                        | twice the rated I <sub>OL</sub> (mA) |
| DC Latchup Source Current<br>(Across Comm Operating Range)             | –500 mA                              |
| Over Voltage Latchup                                                   | V <sub>CC</sub> + 4.5V               |

**Recommended Operating Conditions**

|                                                 |                |
|-------------------------------------------------|----------------|
| Free Air Ambient Temperature                    | –40°C to +85°C |
| Supply Voltage                                  | +4.5V to +5.5V |
| Minimum Input Edge Rate ( $\Delta V/\Delta t$ ) |                |
| Data Input                                      | 50 mV/ns       |
| Enable Input                                    | 20 mV/ns       |

**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

**Note 2:** Either voltage limit or current limit is sufficient to protect inputs.

**DC Electrical Characteristics**

| Symbol           | Parameter                                           | Min        | Typ | Max      | Units      | V <sub>CC</sub> | Conditions                                                                                                                            |
|------------------|-----------------------------------------------------|------------|-----|----------|------------|-----------------|---------------------------------------------------------------------------------------------------------------------------------------|
| V <sub>IH</sub>  | Input HIGH Voltage                                  | 2.0        |     |          | V          |                 | Recognized HIGH Signal                                                                                                                |
| V <sub>IL</sub>  | Input LOW Voltage                                   |            |     | 0.8      | V          |                 | Recognized LOW Signal                                                                                                                 |
| V <sub>CD</sub>  | Input Clamp Diode Voltage                           |            |     | –1.2     | V          | Min             | I <sub>IN</sub> = –18 mA                                                                                                              |
| V <sub>OH</sub>  | Output HIGH Voltage                                 | 2.5<br>2.0 |     |          | V          | Min             | I <sub>OH</sub> = –3 mA<br>I <sub>OH</sub> = –32 mA                                                                                   |
| V <sub>OL</sub>  | Output LOW Voltage                                  |            |     | 0.55     | V          | Min             | I <sub>OL</sub> = 64 mA                                                                                                               |
| I <sub>IH</sub>  | Input HIGH Current                                  |            |     | 1<br>1   | μA         | Max             | V <sub>IN</sub> = 2.7V (Note 3)<br>V <sub>IN</sub> = V <sub>CC</sub>                                                                  |
| I <sub>BVI</sub> | Input HIGH Current<br>Breakdown Test                |            |     | 7        | μA         | Max             | V <sub>IN</sub> = 7.0V                                                                                                                |
| I <sub>IL</sub>  | Input LOW Current                                   |            |     | –1<br>–1 | μA         | Max             | V <sub>IN</sub> = 0.5V (Note 3)<br>V <sub>IN</sub> = 0.0V                                                                             |
| V <sub>ID</sub>  | Input Leakage Test                                  | 4.75       |     |          | V          | 0.0             | I <sub>ID</sub> = 1.9 μA<br>All Other Pins Grounded                                                                                   |
| I <sub>OS</sub>  | Output Short-Circuit Current                        | –100       |     | –275     | mA         | Max             | V <sub>OUT</sub> = 0.0V                                                                                                               |
| I <sub>CEX</sub> | Output HIGH Leakage Current                         |            |     | 50       | μA         | Max             | V <sub>OUT</sub> = V <sub>CC</sub>                                                                                                    |
| I <sub>CCH</sub> | Power Supply Current                                |            |     | 50       | μA         | Max             | All Outputs HIGH                                                                                                                      |
| I <sub>CCL</sub> | Power Supply Current                                |            |     | 30       | mA         | Max             | All Outputs LOW                                                                                                                       |
| I <sub>CCT</sub> | Maximum I <sub>CC</sub> /Input      Outputs Enabled |            |     | 1.5      | mA         | Max             | V <sub>I</sub> = V <sub>CC</sub> – 2.1V<br>Data Input V <sub>I</sub> = V <sub>CC</sub> – 2.1V<br>All Others at V <sub>CC</sub> or GND |
| I <sub>CCD</sub> | Dynamic I <sub>CC</sub> No Load                     |            |     | 0.3      | mA/<br>MHz | Max             | Outputs Open (Note 4)<br>One Bit Toggling, 50% Duty Cycle                                                                             |

**Note 3:** Guaranteed but not tested.

**Note 4:** For 8 bits toggling, I<sub>CCD</sub> < 0.5 mA/MHz.

## AC Electrical Characteristics

(SSOIC package)

| Symbol           | Parameter                                 | T <sub>A</sub> = +25°C<br>V <sub>CC</sub> = +5.0V<br>C <sub>L</sub> = 50 pF |     |     | T <sub>A</sub> = -55°C to +125°C<br>V <sub>CC</sub> = 4.5V to 5.5V<br>C <sub>L</sub> = 50 pF |     | T <sub>A</sub> = -40°C to +85°C<br>V <sub>CC</sub> = 4.5V to 5.5V<br>C <sub>L</sub> = 50 pF |     | Units |
|------------------|-------------------------------------------|-----------------------------------------------------------------------------|-----|-----|----------------------------------------------------------------------------------------------|-----|---------------------------------------------------------------------------------------------|-----|-------|
|                  |                                           | Min                                                                         | Typ | Max | Min                                                                                          | Max | Min                                                                                         | Max |       |
| f <sub>MAX</sub> | Maximum Clock Frequency                   | 150                                                                         | 200 |     | 150                                                                                          |     | 150                                                                                         |     | MHz   |
| t <sub>PLH</sub> | Propagation Delay<br>CP to O <sub>n</sub> | 2.0                                                                         |     | 6.0 | 1.0                                                                                          | 7.0 | 2.0                                                                                         | 6.0 | ns    |
| t <sub>PHL</sub> | Propagation Delay<br>MR to O <sub>n</sub> | 2.8                                                                         |     | 6.8 | 1.0                                                                                          | 7.5 | 2.8                                                                                         | 6.8 | ns    |
| t <sub>PHL</sub> | Propagation Delay<br>MR to O <sub>n</sub> | 2.5                                                                         |     | 7.4 | 1.0                                                                                          | 8.2 | 2.5                                                                                         | 7.4 | ns    |

## AC Operating Requirements

| Symbol             | Parameter                        | T <sub>A</sub> = +25°C<br>V <sub>CC</sub> = +5.0V<br>C <sub>L</sub> = 50 pF |     | T <sub>A</sub> = -55°C to +125°C<br>V <sub>CC</sub> = 4.5V to 5.5V<br>C <sub>L</sub> = 50 pF |     | T <sub>A</sub> = -40°C to +85°C<br>V <sub>CC</sub> = 4.5V to 5.5V<br>C <sub>L</sub> = 50 pF |     | Units |
|--------------------|----------------------------------|-----------------------------------------------------------------------------|-----|----------------------------------------------------------------------------------------------|-----|---------------------------------------------------------------------------------------------|-----|-------|
|                    |                                  | Min                                                                         | Max | Min                                                                                          | Max | Min                                                                                         | Max |       |
| t <sub>S</sub> (H) | Setup Time, HIGH                 | 2.0                                                                         |     | 2.0                                                                                          |     | 2.0                                                                                         |     | ns    |
| t <sub>S</sub> (L) | or LOW D <sub>n</sub> to CP      | 2.5                                                                         |     | 2.5                                                                                          |     | 2.5                                                                                         |     | ns    |
| t <sub>H</sub> (H) | Hold Time, HIGH                  | 1.2                                                                         |     | 1.4                                                                                          |     | 1.2                                                                                         |     | ns    |
| t <sub>H</sub> (L) | or LOW D <sub>n</sub> to CP      | 1.2                                                                         |     | 1.4                                                                                          |     | 1.2                                                                                         |     | ns    |
| t <sub>W</sub> (H) | Pulse Width, CP,                 | 3.3                                                                         |     | 3.3                                                                                          |     | 3.3                                                                                         |     | ns    |
| t <sub>W</sub> (L) | HIGH or LOW                      | 3.3                                                                         |     | 3.3                                                                                          |     | 3.3                                                                                         |     | ns    |
| t <sub>W</sub> (L) | Master Reset Pulse<br>Width, LOW | 3.3                                                                         |     | 3.3                                                                                          |     | 3.3                                                                                         |     | ns    |
| t <sub>REC</sub>   | Recovery Time<br>MR to CP        | 2.0                                                                         |     | 2.0                                                                                          |     | 2.0                                                                                         |     | ns    |

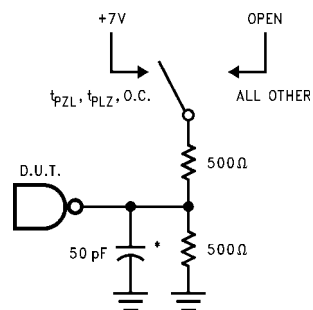
## Capacitance

(SOIC package)

| Symbol                    | Parameter          | Typ | Units | Conditions<br>T <sub>A</sub> = 25°C |
|---------------------------|--------------------|-----|-------|-------------------------------------|
| C <sub>IN</sub>           | Input Capacitance  | 5   | pF    | V <sub>CC</sub> = 0V                |
| C <sub>OUT</sub> (Note 5) | Output Capacitance | 9   | pF    | V <sub>CC</sub> = 5.0V              |

**Note 5:** C<sub>OUT</sub> is measured at frequency f = 1 MHz, per MIL-STD-883C, Method 3012.

## AC Loading



\*Includes jig and probe capacitance

FIGURE 1. Standard AC Test Load

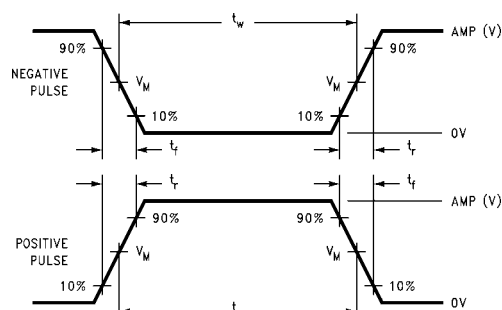


FIGURE 2.  $V_M = 1.5V$   
Input Pulse Requirements

| Amplitude | Rep. Rate | $t_w$  | $t_r$  | $t_f$  |
|-----------|-----------|--------|--------|--------|
| 3.0V      | 1 MHz     | 500 ns | 2.5 ns | 2.5 ns |

FIGURE 3. Test Input Signal Requirements

## AC Waveforms

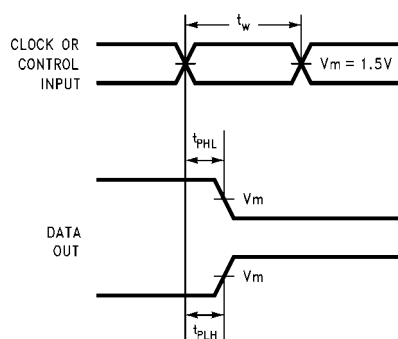


FIGURE 4. Propagation Delay,  
Pulse Width Waveforms

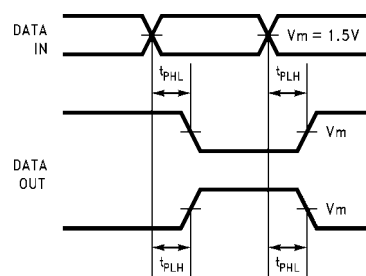


FIGURE 6. Propagation Delay Waveforms for  
Inverting and Non-Inverting Functions

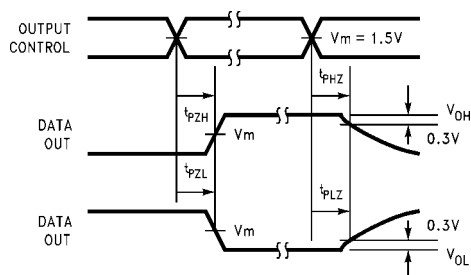


FIGURE 5. 3-STATE Output HIGH  
and LOW Enable and Disable Times

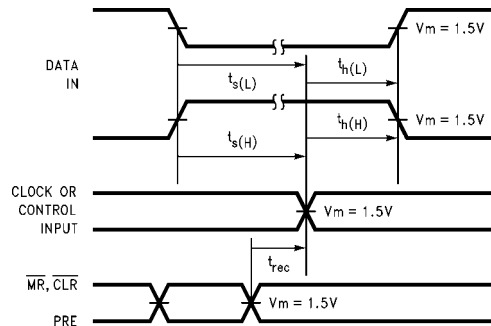
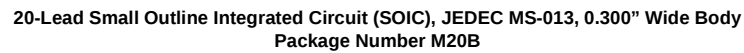
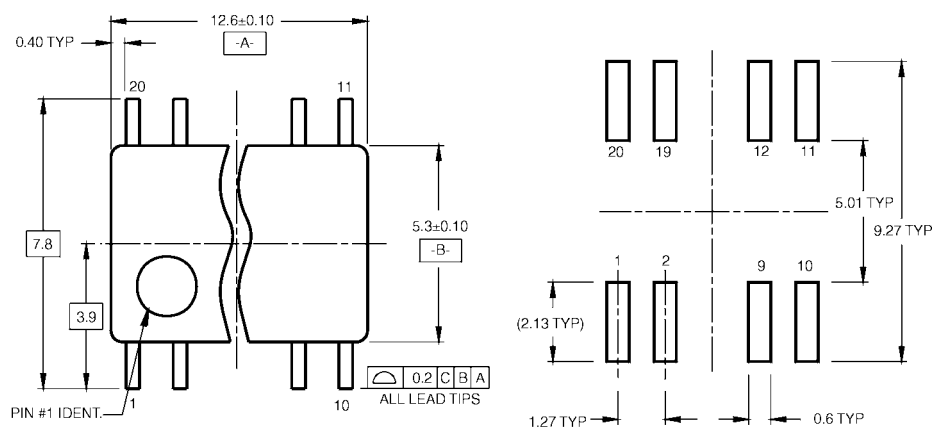
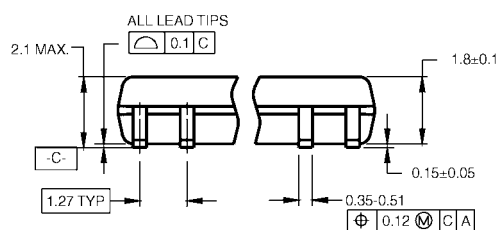
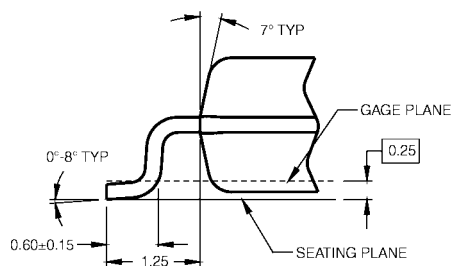
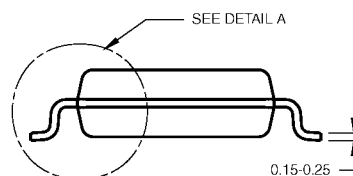


FIGURE 7. Setup Time, Hold Time  
and Recovery Time Waveforms



**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)

**LAND PATTERN RECOMMENDATION**


DIMENSIONS ARE IN MILLIMETERS

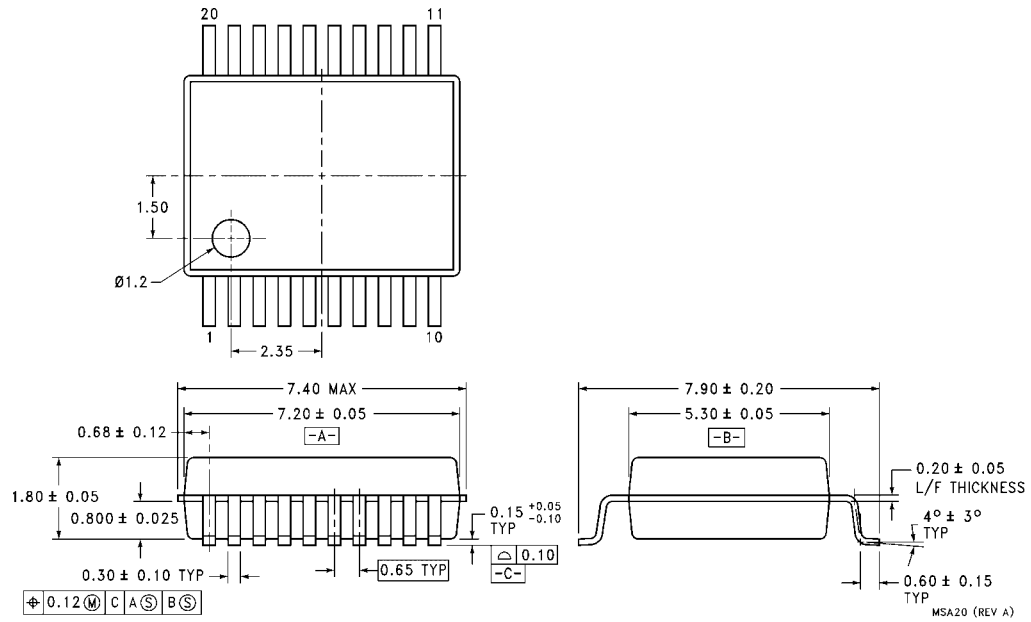

**DETAIL A**
**NOTES:**

- CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

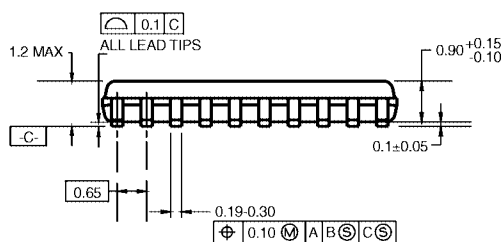
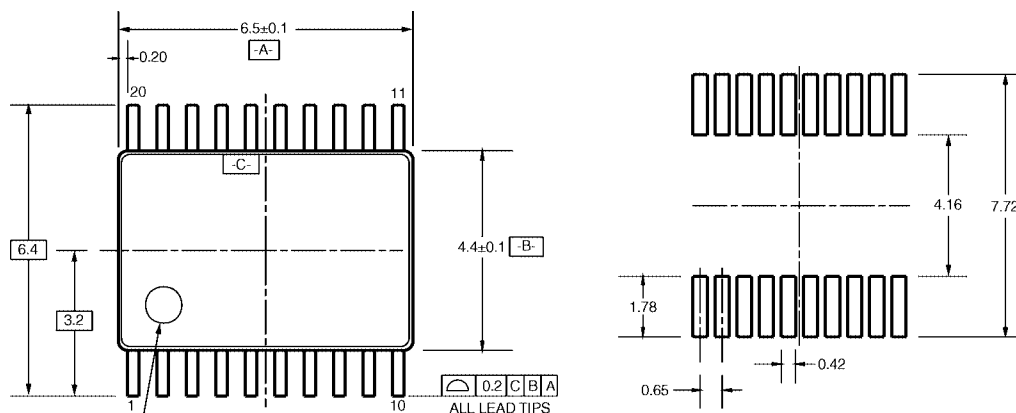
M20DRevB1

**20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide**  
**Package Number M20D**

# Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide  
Package Number MSA20

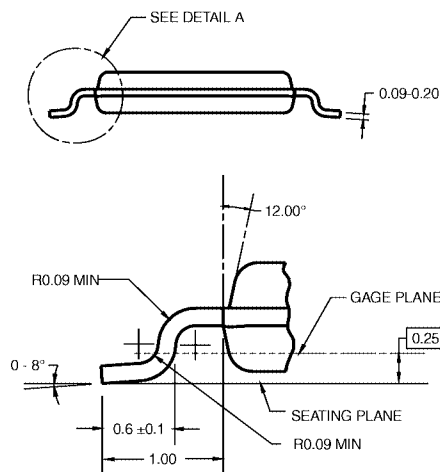
**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)

DIMENSIONS ARE IN MILLIMETERS

**NOTES:**

- CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AC, REF NOTE 6, DATE 7/93.
- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MTC20RevD1

**DETAIL A****20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide  
Package Number MTC20**

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- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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